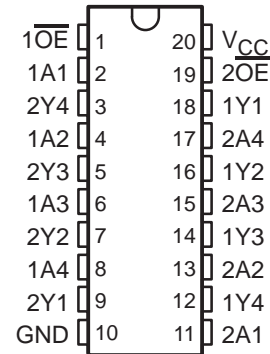


# SN74LVC240 OCTAL BUFFER/DRIVER WITH 3-STATE OUTPUTS

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- **EPIC™** (Enhanced-Performance Implanted CMOS) Submicron Process
- Typical  $V_{OLP}$  (Output Ground Bounce)  $< 0.8\text{ V}$  at  $V_{CC} = 3.3\text{ V}$ ,  $T_A = 25^\circ\text{C}$
- Typical  $V_{OHV}$  (Output  $V_{OH}$  Undershoot)  $> 2\text{ V}$  at  $V_{CC} = 3.3\text{ V}$ ,  $T_A = 25^\circ\text{C}$
- Latch-Up Performance Exceeds 250 mA Per JEDEC Standard JESD-17
- Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages

DB, DW, OR PW PACKAGE  
(TOP VIEW)



## description

This octal buffer/driver is designed for 2.7-V to 3.6-V  $V_{CC}$  operation.

The SN74LVC240 is designed specifically to improve the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters.

The SN74LVC240 is organized as two 4-bit buffers/drivers with separate output-enable ( $\overline{OE}$ ) inputs. When  $\overline{OE}$  is low, the device passes data from the A inputs to the Y outputs. When  $\overline{OE}$  is high, the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74LVC240 is characterized for operation from  $-40^\circ\text{C}$  to  $85^\circ\text{C}$ .

FUNCTION TABLE  
(each buffer)

| INPUTS          |   | OUTPUT |
|-----------------|---|--------|
| $\overline{OE}$ | A | Y      |
| L               | H | L      |
| L               | L | H      |
| H               | X | Z      |



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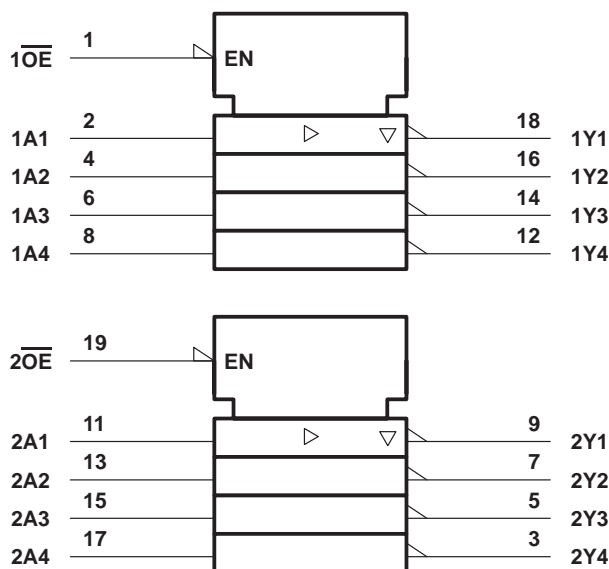
PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

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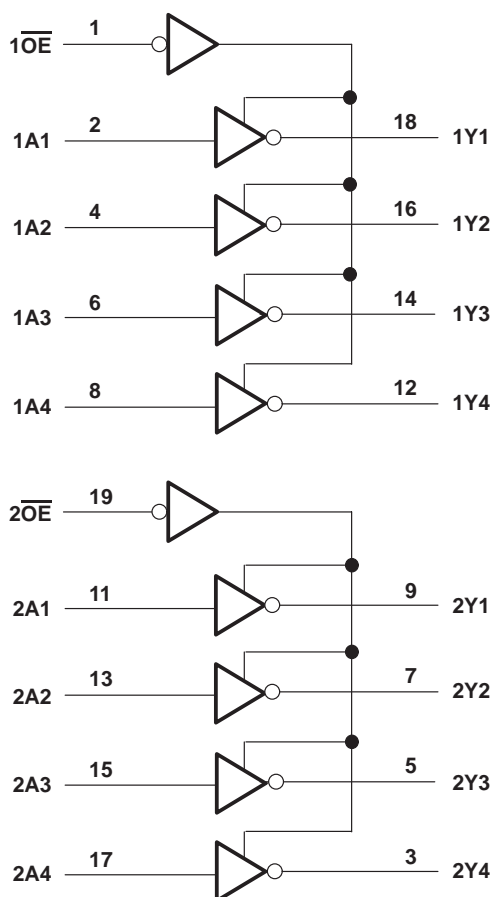
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**logic symbol†**



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

**logic diagram (positive logic)**



**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡**

|  |                            |
|--|----------------------------|
| Supply voltage range, $V_{CC}$   | –0.5 V to 4.6 V            |
| Input voltage range, $V_I$ (see Note 1)  | –0.5 V to 6.5 V            |
| Output voltage range, $V_O$ (see Notes 1 and 2)                                    | –0.5 V to $V_{CC} + 0.5$ V |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ )  | –50 mA                     |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ )                     | ±50 mA                     |
| Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )                         | ±50 mA                     |
| Continuous current through $V_{CC}$ or GND   | ±100 mA                    |
| Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air) (see Note 3): |                            |
| DB package   | 0.6 W                      |
| DW package   | 1.6 W                      |
| PW package   | 0.7 W                      |
| Operating free-air temperature range, $T_A$  | –40°C to 85°C              |
| Storage temperature range, $T_{stg}$   | –65°C to 150°C             |

‡ Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.  
 2. This value is limited to 4.6 V maximum.  
 3. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils. For more information, refer to the *Package Thermal Considerations* application note in the 1994 *ABT Advanced BiCMOS Technology Data Book*, literature number SCBD002B.

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**OCTAL BUFFER/DRIVER**  
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**recommended operating conditions (see Note 4)**

|                     |                                    |  | MIN | MAX      | UNIT |
|---------------------|------------------------------------|--|-----|----------|------|
| $V_{CC}$            | Supply voltage                     |  | 2.7 | 3.6      | V    |
| $V_{IH}$            | High-level input voltage           | $V_{CC} = 2.7\text{ V to } 3.6\text{ V}$ | 2   |          | V    |
| $V_{IL}$            | Low-level input voltage            | $V_{CC} = 2.7\text{ V to } 3.6\text{ V}$ |     | 0.8      | V    |
| $V_I$               | Input voltage                      |  | 0   | 5.5      | V    |
| $V_O$               | Output voltage                     |  | 0   | $V_{CC}$ | V    |
| $I_{OH}$            | High-level output current          | $V_{CC} = 2.7\text{ V}$                  |     | –12      | mA   |
|                     |                                    | $V_{CC} = 3\text{ V}$                    |     | –24      |      |
| $I_{OL}$            | Low-level output current           | $V_{CC} = 2.7\text{ V}$                  |     | 12       | mA   |
|                     |                                    | $V_{CC} = 3\text{ V}$                    |     | 24       |      |
| $\Delta t/\Delta v$ | Input transition rise or fall rate |  | 0   | 10       | ns/V |
| $T_A$               | Operating free-air temperature     |  | –40 | 85       | °C   |

NOTE 4: Unused inputs must be held high or low to prevent them from floating.

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

| PARAMETER        | TEST CONDITIONS  | V <sub>CC</sub> <sup>†</sup> | MIN                  | TYP <sup>‡</sup> | MAX | UNIT |
|------------------|--|------------------------------|----------------------|------------------|-----|------|
| V <sub>OH</sub>  | I <sub>OH</sub> = −100 μA  | MIN to MAX                   | V <sub>CC</sub> −0.2 |                  | V   |      |
|                  | I <sub>OH</sub> = −12 mA   | 2.7 V                        | 2.2                  |                  |     |      |
|                  |  | 3 V                          | 2.4                  |                  |     |      |
|                  | I <sub>OH</sub> = −24 mA   | 3 V                          | 2                    |                  |     |      |
| V <sub>OL</sub>  | I <sub>OL</sub> = 100 μA   | MIN to MAX                   | 0.2                  |                  | V   |      |
|                  | I <sub>OL</sub> = 12 mA  | 2.7 V                        | 0.4                  |                  |     |      |
|                  | I <sub>OL</sub> = 24 mA  | 3 V                          | 0.55                 |                  |     |      |
| I <sub>I</sub>   | V <sub>I</sub> = 5.5 V or GND  | 3.6 V                        | ±5                   |                  | μA  |      |
| I <sub>OZ</sub>  | V <sub>O</sub> = V <sub>CC</sub> or GND                                      | 3.6 V                        | ±10                  |                  | μA  |      |
| I <sub>CC</sub>  | V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0                  | 3.6 V                        | 20                   |                  | μA  |      |
| ΔI <sub>CC</sub> | One input at V <sub>CC</sub> − 0.6 V, Other inputs at V <sub>CC</sub> or GND | 3 V to 3.6 V                 | 500                  |                  | μA  |      |
| C <sub>i</sub>   | V <sub>I</sub> = V <sub>CC</sub> or GND                                      | 3.3 V                        | 5.5                  |                  | pF  |      |
| C <sub>o</sub>   | V <sub>O</sub> = V <sub>CC</sub> or GND                                      | 3.3 V                        | 5.8                  |                  | pF  |      |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate values under recommended operating conditions.

<sup>‡</sup> All typical values are at  $V_{CC} = 3.3\text{ V, } T_A = 25^\circ\text{C}$ .

**switching characteristics over recommended operating free-air temperature range,  $C_L = 50\text{ pF}$  (unless otherwise noted) (see Figure 1)**

| PARAMETER | FROM<br>(INPUT) | TO<br>(OUTPUT) | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ |     | $V_{CC} = 2.7\text{ V}$ |     | UNIT |
|-----------|-----------------|----------------|--|-----|-------------------------|-----|------|
|           |                 |                | MIN                                      | MAX | MIN                     | MAX |      |
| $t_{pd}$  | A               | Y              | 1.5                                      | 7.5 | 8.5                     |     | ns   |
| $t_{en}$  | $\overline{OE}$ | Y              | 1.5                                      | 8   | 9                       |     | ns   |
| $t_{dis}$ | $\overline{OE}$ | Y              | 1.5                                      | 7.5 | 8.5                     |     | ns   |



# SN74LVC240

## OCTAL BUFFER/DRIVER

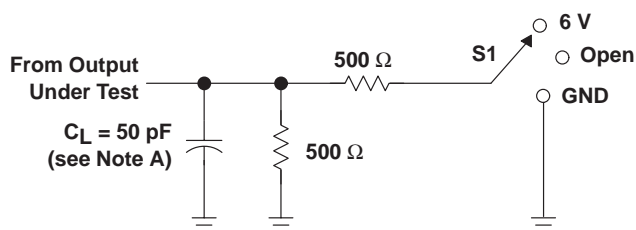
### WITH 3-STATE OUTPUTS

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operating characteristics,  $V_{CC} = 3.3 \text{ V}$ ,  $T_A = 25^\circ\text{C}$

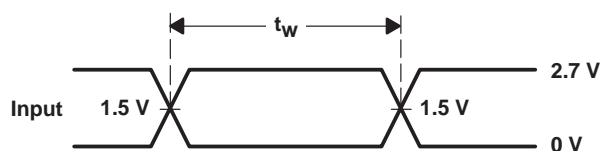
| PARAMETER |   | TEST CONDITIONS                              | TYP | UNIT |
|-----------|---|--|-----|------|
| $C_{pd}$  | Power dissipation capacitance per buffer/driver | $C_L = 50 \text{ pF}$ , $f = 10 \text{ MHz}$ | 24  | pF   |
|           | Outputs enabled                                 |  | 2.5 |      |

## PARAMETER MEASUREMENT INFORMATION

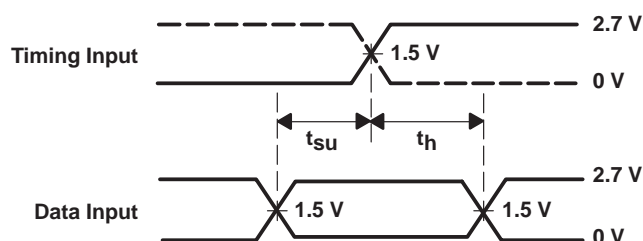


LOAD CIRCUIT FOR OUTPUTS

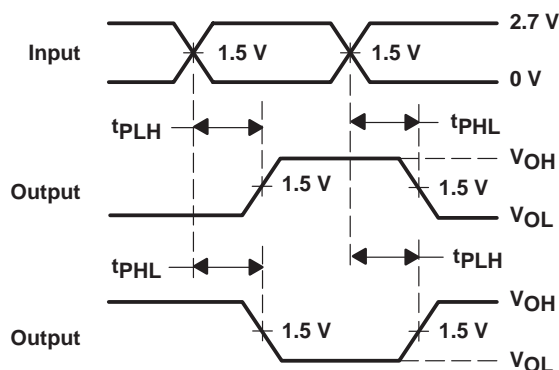
| TEST              | S1   |
|-------------------|------|
| $t_{pd}$          | Open |
| $t_{PLZ}/t_{PZL}$ | 6 V  |
| $t_{PHZ}/t_{PHL}$ | GND  |



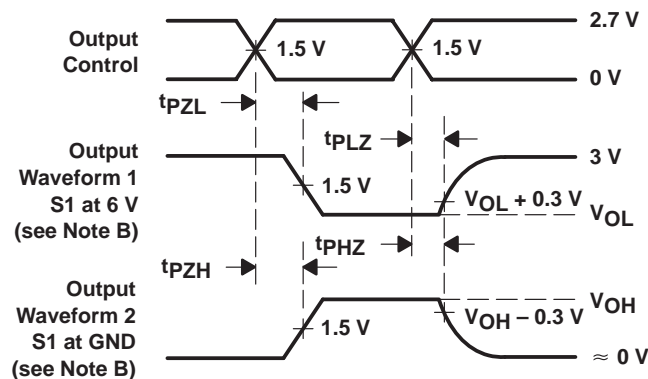
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .
  - The outputs are measured one at a time with one transition per measurement.
  - $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 1. Load Circuit and Voltage Waveforms



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